www.DataSheet4U.com



PMEG3005CT

500 mA low V_F dual MEGA Schottky barrier rectifier Rev. 01 — 5 June 2009

Product data sheet

Product profile 1.

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier in common cathode configuration with an integrated guard ring for stress protection, encapsulated in a SOT23 (TO-236AB) small Surface-Mounted Device (SMD) plastic package.

1.2 Features

- Average forward current: $I_{F(AV)} \le 0.5 A$
- Reverse voltage: $V_R \le 30 \text{ V}$
- Low forward voltage

1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)

- AEC-Q101 qualified
- Small SMD plastic package
- Reverse polarity protection
- High-speed switching
- Low power consumption applications

1.4 Quick reference data

Table 1. Quick reference data

 $T_i = 25 \circ C$ unless otherwise specified.

Parameter	Conditions	Min	Тур	Max	Unit
average forward current	square wave; $\delta = 0.5$; f = 20 kHz				
	$T_{amb} \le 95 \ ^{\circ}C$	<u>[1]</u> _	-	0.5	А
	$T_{sp} \le 130 \ ^{\circ}C$	-	-	0.5	А
reverse voltage		-	-	30	V
forward voltage	I _F = 0.5 A	-	375	430	mV
reverse current	V _R = 30 V	-	40	150	μA
	average forward current reverse voltage forward voltage	$\label{eq:second} \begin{array}{l} \text{average forward current} \\ \text{average forward current} \\ \frac{\delta = 0.5;}{f = 20 \text{ kHz}} \\ \overline{T_{amb} \leq 95 \ ^{\circ}\text{C}} \\ \overline{T_{sp} \leq 130 \ ^{\circ}\text{C}} \\ \hline \end{array} \\ \hline \end{array}$	$\begin{array}{c} \text{average forward current} \\ \text{average forward current} \\ & \begin{array}{c} \text{square wave;} \\ \delta = 0.5; \\ \text{f} = 20 \text{ kHz} \\ \hline \\ T_{amb} \leq 95 \ ^{\circ}\text{C} & \begin{array}{c} 11 \\ - \\ \hline \\ T_{sp} \leq 130 \ ^{\circ}\text{C} & - \\ \end{array} \\ \hline \text{reverse voltage} & \begin{array}{c} - \\ \hline \\ \text{forward voltage} & I_F = 0.5 \ \text{A} & - \\ \end{array} \end{array}$	$\label{eq:average forward current} average forward current \begin{array}{c} square wave; \\ \delta = 0.5; \\ f = 20 \text{ kHz} \\ \hline T_{amb} \leq 95 \ ^\circ C \fbox{[1]} - & - \\ \hline T_{sp} \leq 130 \ ^\circ C & - & - \\ \hline \end{array} \\ \hline reverse \ voltage & I_F = 0.5 \ A & - & 375 \end{array}$	$\begin{array}{c} \text{average forward current} \\ & \begin{array}{c} \text{square wave;} \\ \delta = 0.5; \\ \text{f} = 20 \text{ kHz} \\ \hline T_{amb} \leq 95 \ ^{\circ}\text{C} & \begin{array}{c} 11 \\ - \end{array} & - & 0.5 \\ \hline T_{sp} \leq 130 \ ^{\circ}\text{C} & - & - & 0.5 \\ \hline \end{array} \\ \hline \text{reverse voltage} & \begin{array}{c} - & 30 \\ 1 \\ \text{forward voltage} \end{array} & I_{F} = 0.5 \ \text{A} & - & 375 \end{array} \\ \end{array}$

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.



www.DataSheet4U.com



500 mA low V_F dual MEGA Schottky barrier rectifier

Pinning information 2.

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	anode (diode 1)		_
2	anode (diode 2)		3
3	common cathode	1 2	
			006aab034

Ordering information 3.

Table 3. Orderin	ng informatio	n	
Type number	Package		
	Name	Description	Version
PMEG3005CT	-	plastic surface-mounted package; 3 leads	SOT23

Marking 4.

Table 4. Marking codes	
Type number	Marking code ^[1]
PMEG3005CT	P9*
[1] * = -: made in Hong Kong	

- iy * = p: made in Hong Kong
- * = t: made in Malaysia
- * = W: made in China

Limiting values 5.

Table 5. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V _R	reverse voltage	$T_j = 25 \ ^{\circ}C$	-	30	V
I _{F(AV)}	average forward current	square wave; $\delta = 0.5$; f = 20 kHz			
		$T_{amb} \le 95 \ ^{\circ}C$	<u>[1]</u> _	0.5	А
		$T_{sp} \le 130 \ ^{\circ}C$	-	0.5	А
I _{FRM}	repetitive peak forward current	$\begin{array}{l} t_p \leq 1 \text{ ms}; \\ \delta \leq 0.25 \end{array}$	-	3.9	А
I _{FSM}	non-repetitive peak forward current	square wave; t _p = 8 ms	[2] _	10	A

2 of 13

500 mA low V_F dual MEGA Schottky barrier rectifier

Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per device; o	ne diode loaded				
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[3]</u> _	330	mW
			<u>[4]</u> _	400	mW
			<u>[1]</u> -	460	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

[2] $T_j = 25 \,^{\circ}C$ prior to surge.

- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode	; one diode loaded					
R _{th(j-a)}	thermal resistance from	in free air	<u>[1]</u>			
junction to ambient	n to ambient	[2] _	-	375	K/W	
			[3] _	-	310	K/W
			<u>[4]</u> _	-	270	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[5] _	-	60	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

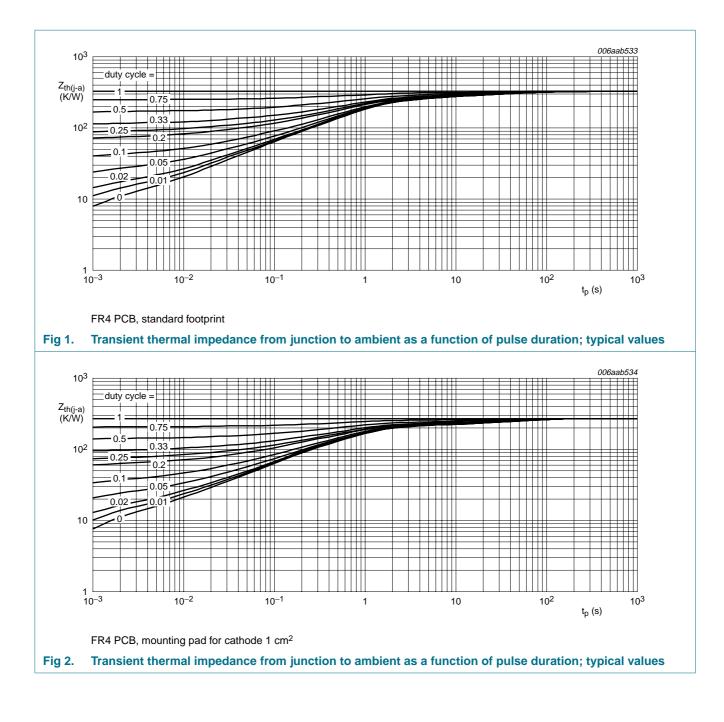
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

[5] Soldering point of cathode tab.

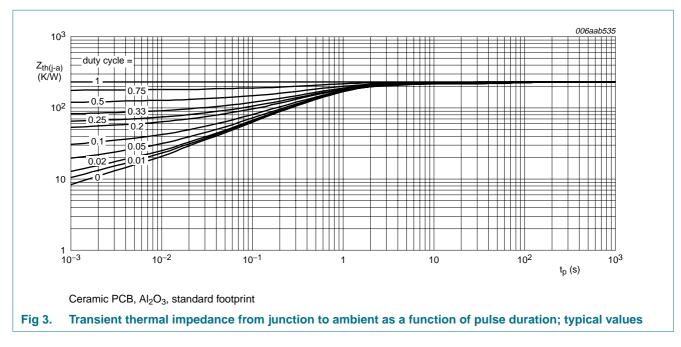


500 mA low V_F dual MEGA Schottky barrier rectifier





500 mA low V_F dual MEGA Schottky barrier rectifier



Characteristics 7.

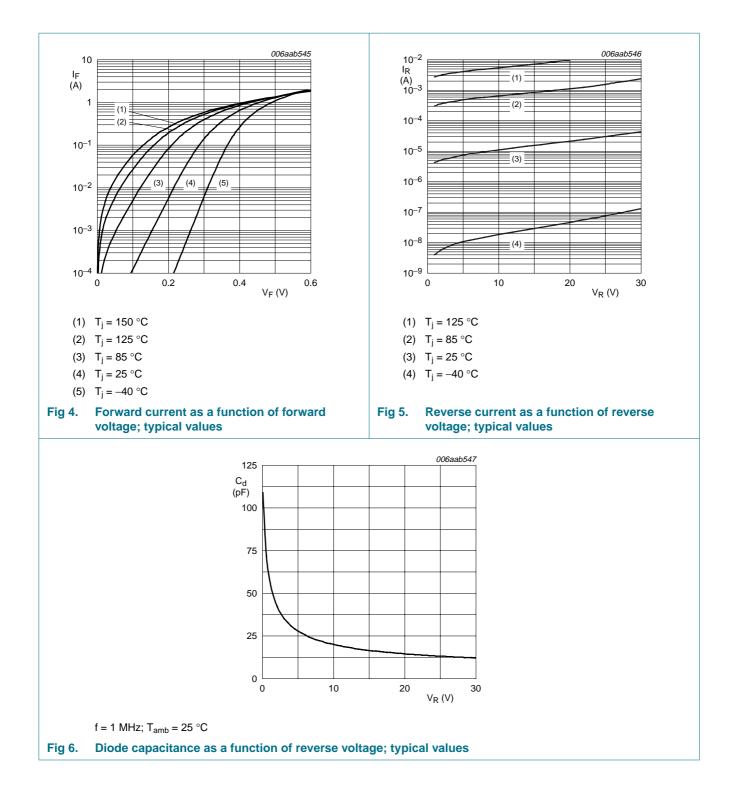
Table 7. **Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V _F	forward voltage	I _F = 0.1 mA	-	95	130	mV
	I _F = 1 mA	-	155	200	mV	
	I _F = 10 mA	-	215	250	mV	
		I _F = 100 mA	-	290	340	mV
		I _F = 500 mA	-	375	430	mV
I _R	reverse current	V _R = 10 V	-	10	30	μΑ
		V _R = 30 V	-	40	150	μA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz	-	55	70	pF
t _{rr}	reverse recovery time		<u>[1]</u> _	17	-	ns

[1] When switched from I_F = 10 mA to I_R = 10 mA; R_L = 100 Ω ; measured at I_R = 1 mA.



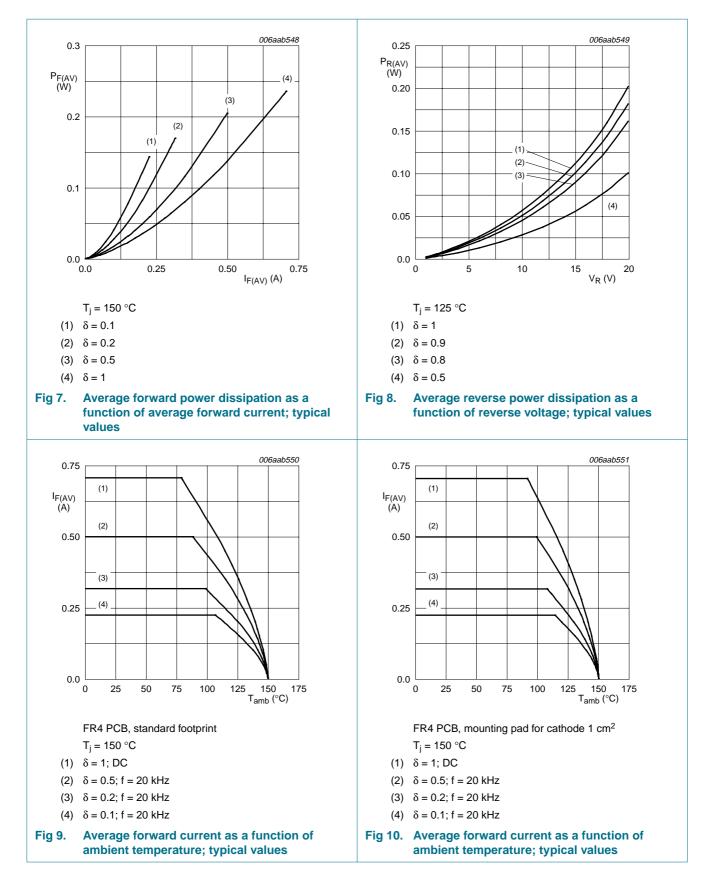
500 mA low V_F dual MEGA Schottky barrier rectifier



www.DataSheet4U.com NXP Semiconductors

PMEG3005CT

500 mA low V_F dual MEGA Schottky barrier rectifier

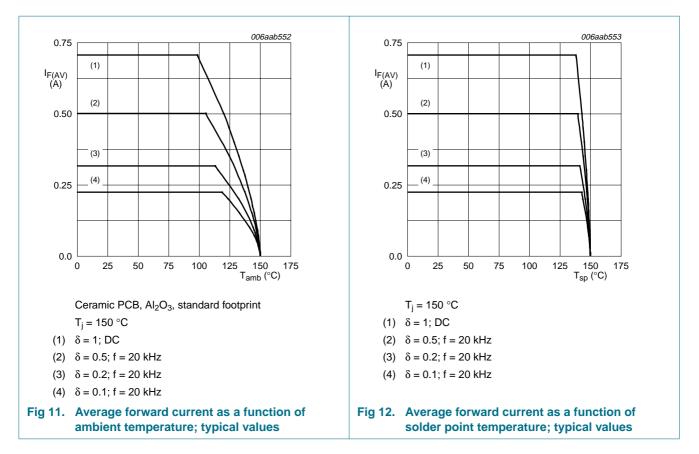


© NXP B.V. 2009. All rights reserved.

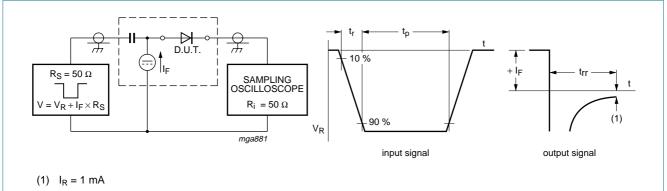
www.DataSheet4U.com NXP Semiconductors

PMEG3005CT

500 mA low V_F dual MEGA Schottky barrier rectifier



8. Test information

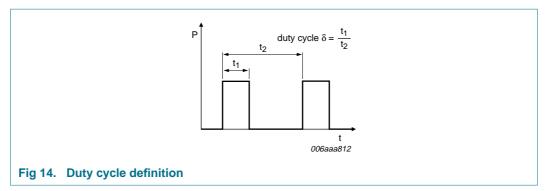


Input signal: reverse pulse rise time $t_r = 0.6$ ns; reverse voltage pulse duration $t_p = 100$ ns; duty cycle $\delta = 0.05$ Oscilloscope: rise time $t_r = 0.35$ ns

Fig 13. Reverse recovery time test circuit and waveforms



500 mA low V_F dual MEGA Schottky barrier rectifier



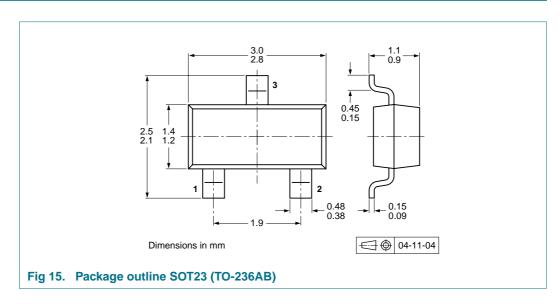
The current ratings for the typical waveforms as shown in Figure 9, 10, 11 and 12 are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current,

 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



10. Packing information

Table 8. Packing methods

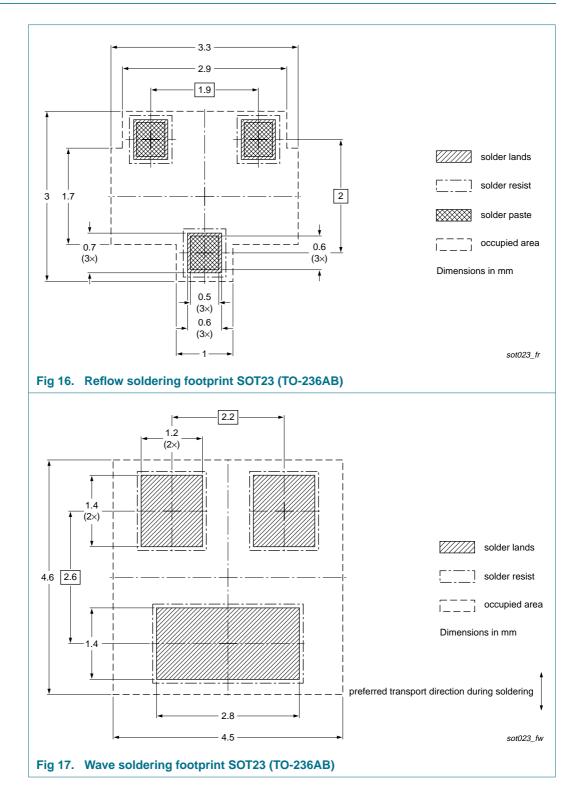
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			3000	10000
PMEG3005CT	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

[1] For further information and the availability of packing methods, see Section 14.

500 mA low V_F dual MEGA Schottky barrier rectifier

11. Soldering



500 mA low V_F dual MEGA Schottky barrier rectifier

12. Revision history

Table 9. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEG3005CT_1	20090605	Product data sheet	-	-

500 mA low V_F dual MEGA Schottky barrier rectifier

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

13.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

13.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

14. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

PMEG3005CT_1 Product data sheet



500 mA low V_F dual MEGA Schottky barrier rectifier

15. Contents

1	Product profile 1
1.1	General description
1.2	Features
1.3	Applications 1
1.4	Quick reference data
2	Pinning information 2
3	Ordering information 2
4	Marking
5	Limiting values 2
6	Thermal characteristics 3
7	Characteristics 5
8	Test information 8
8.1	Quality information 9
9	Package outline 9
10	Packing information9
11	Soldering 10
12	Revision history 11
13	Legal information 12
13.1	Data sheet status 12
13.2	Definitions 12
13.3	Disclaimers
13.4	Trademarks 12
14	Contact information 12
15	Contents 13

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2009.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 5 June 2009 Document identifier: PMEG3005CT_1

